

# Complementary NPN-PNP Silicon Power Bipolar Transistor

The MJL3281A and MJL1302A are PowerBase<sup>™</sup> power transistors for high power audio, disk head positioners and other linear applications.

- Designed for 100 W Audio Frequency
- Gain Complementary:

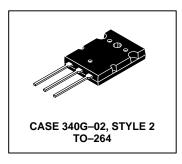
Gain Linearity from 100 mA to 7 A High Gain — 60 to 175  $h_{FE} = 45$  (Min) @  $I_{C} = 8$  A

- Low Harmonic Distortion
- High Safe Operation Area 1 A/100 V @ 1 Second
- High f<sub>T</sub> 30 MHz Typical

### MJL3281A\* PNP MJL1302A\*

\*ON Semiconductor Preferred Device

15 AMPERE
COMPLEMENTARY
SILICON POWER
TRANSISTORS
200 VOLTS
200 WATTS



#### **MAXIMUM RATINGS** (T<sub>.J</sub> = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	VCEO	200	Vdc
Collector–Base Voltage	VCBO	200	Vdc
Emitter–Base Voltage	VEBO	7	Vdc
Collector–Emitter Voltage – 1.5 V	VCEX	200	Vdc
Collector Current — Continuous — Peak (1)	IC	15 25	Adc
Base Current — Continuous	ΙΒ	1.5	Adc
Total Power Dissipation @ T <sub>C</sub> = 25°C Derate Above 25°C	PD	200 1.43	Watts W/°C
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +150	°C

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	0.7	°C/W

#### **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS					
Collector–Emitter Sustaining Voltage (I <sub>C</sub> = 100 mAdc, I <sub>B</sub> = 0)	VCEO(sus)	200	_	_	Vdc
Emitter–Base Voltage (I <sub>E</sub> = 100 μAdc, I <sub>C</sub> = 0)	V <sub>EBO</sub>	7	_	_	Vdc

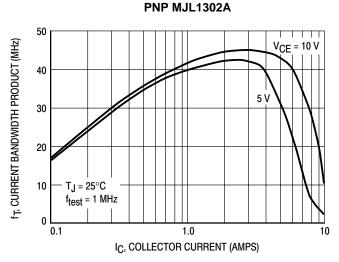
<sup>(1)</sup> Pulse Test: Pulse Width = 5 ms, Duty Cycle < 10%.

(continued)

Preferred devices are ON Semiconductor recommended choices for future use and best overall value.

#### **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS					
Collector Cutoff Current (V <sub>CB</sub> = 200 Vdc, I <sub>E</sub> = 0)	ICBO	_	_	50	μAdc
Emitter Cutoff Current (V <sub>EB</sub> = 5 Vdc, I <sub>C</sub> = 0)	IEBO	_	_	5	μAdc
Emitter Cutoff Current (V <sub>EB</sub> = 7 Vdc, I <sub>C</sub> = 0)	IEBO	_	_	25	μAdc
SECOND BREAKDOWN					
Second Breakdown Collector with Base Forward Biased (V <sub>CE</sub> = 50 Vdc, t = 1 s (non–repetitive) (V <sub>CE</sub> = 100 Vdc, t = 1 s (non–repetitive)	I <sub>S/b</sub>	4 1	_	_	Adc
ON CHARACTERISTICS				l	
DC Current Gain $(IC = 100 \text{ mAdc}, V_{CE} = 5 \text{ Vdc})$ $(IC = 1 \text{ Adc}, V_{CE} = 5 \text{ Vdc})$ $(IC = 3 \text{ Adc}, V_{CE} = 5 \text{ Vdc})$ $(IC = 5 \text{ Adc}, V_{CE} = 5 \text{ Vdc})$ $(IC = 7 \text{ Adc}, V_{CE} = 5 \text{ Vdc})$ $(IC = 8 \text{ Adc}, V_{CE} = 5 \text{ Vdc})$ $(IC = 15 \text{ Adc}, V_{CE} = 5 \text{ Vdc})$	hFE	60 60 60 60 60 45 12	125 — — — 115 — 35	175 175 175 175 175 175 —	
Collector–Emitter Saturation Voltage (I <sub>C</sub> = 10 Adc, I <sub>B</sub> = 1 Adc)	VCE(sat)	_	_	3	Vdc
DYNAMIC CHARACTERISTICS			•		•
Current–Gain — Bandwidth Product (I <sub>C</sub> = 1 Adc, V <sub>CE</sub> = 5 Vdc, f <sub>test</sub> = 1 MHz)	fT	_	30	_	MHz
Output Capacitance (V <sub>CB</sub> = 10 Vdc, I <sub>E</sub> = 0, f <sub>test</sub> = 1 MHz)	C <sub>ob</sub>	_	_	600	pF





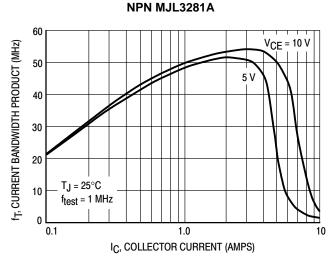


Figure 2. Typical Current Gain Bandwidth Product

#### **TYPICAL CHARACTERISTICS**

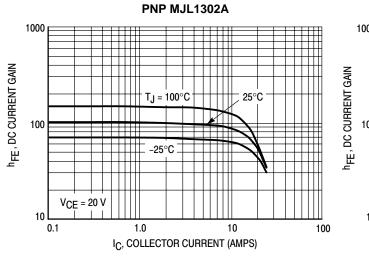


Figure 3. DC Current Gain, V<sub>CE</sub> = 20 V

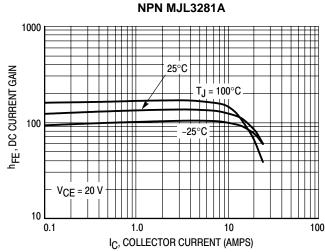


Figure 4. DC Current Gain, VCE = 20 V

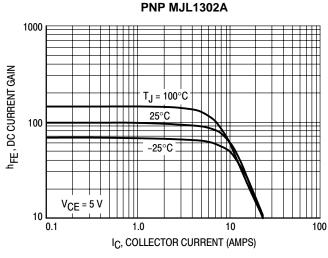


Figure 5. DC Current Gain, VCE = 5 V

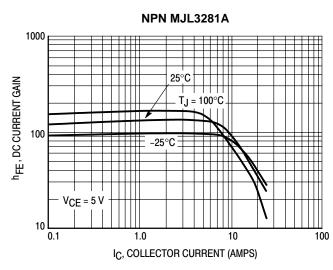
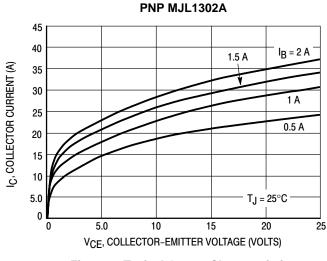


Figure 6. DC Current Gain, VCE = 5 V



**Figure 7. Typical Output Characteristics** 

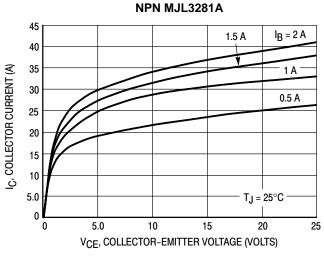


Figure 8. Typical Output Characteristics

#### TYPICAL CHARACTERISTICS

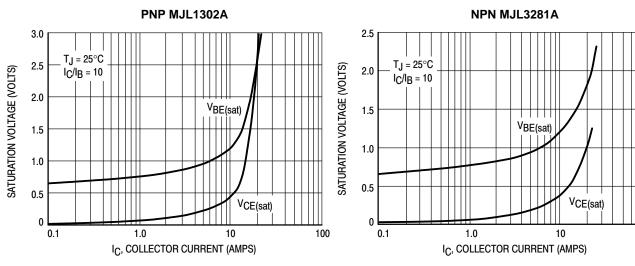


Figure 9. Typical Saturation Voltages

Figure 10. Typical Saturation Voltages

100

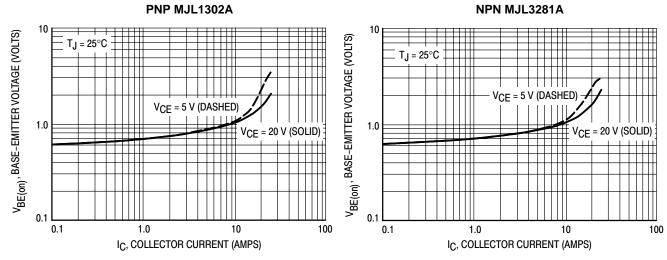


Figure 11. Typical Base-Emitter Voltage



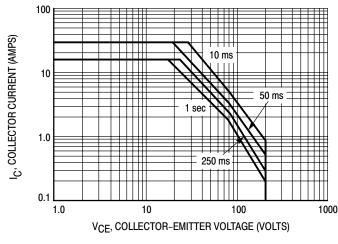


Figure 13. Active Region Safe Operating Area

There are two limitations on the power handling ability of a transistor; average junction temperature and secondary breakdown. Safe operating area curves indicate  $I_C - V_{CE}$  limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 13 is based on  $T_{J(pk)} = 150^{\circ}C$ ;  $T_{C}$  is variable depending on conditions. At high case temperatures, thermal limitations will reduce the power than can be handled to values less than the limitations imposed by second breakdown.

#### **TYPICAL CHARACTERISTICS**

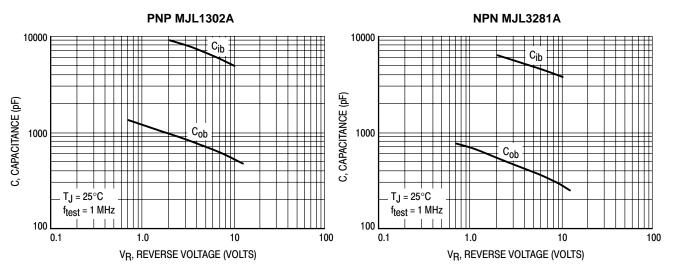


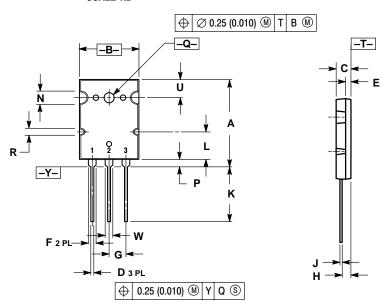
Figure 14. MJL1302A Typical Capacitance

Figure 15. MJL3281A Typical Capacitance

#### **PACKAGE DIMENSIONS**

## TO-3PBL (TO-264) CASE 340G-02 ISSUE H

#### SCALE 1:2



- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: MILLIMETER.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	28.0	29.0	1.102	1.142
В	19.3	20.3	0.760	0.800
С	4.7	5.3	0.185	0.209
D	0.93	1.48	0.037	0.058
Е	1.9	2.1	0.075	0.083
F	2.2	2.4	0.087	0.102
G	5.45 BSC		0.215 BSC	
Н	2.6	3.0	0.102	0.118
J	0.43	0.78	0.017	0.031
K	17.6	18.8	0.693	0.740
L	11.0	11.4	0.433	0.449
N	3.95	4.75	0.156	0.187
P	2.2	2.6	0.087	0.102
Q	3.1	3.5	0.122	0.137
R	2.15	2.35	0.085	0.093
U	6.1	6.5	0.240	0.256
W	2.8	3.2	0.110	0.125



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